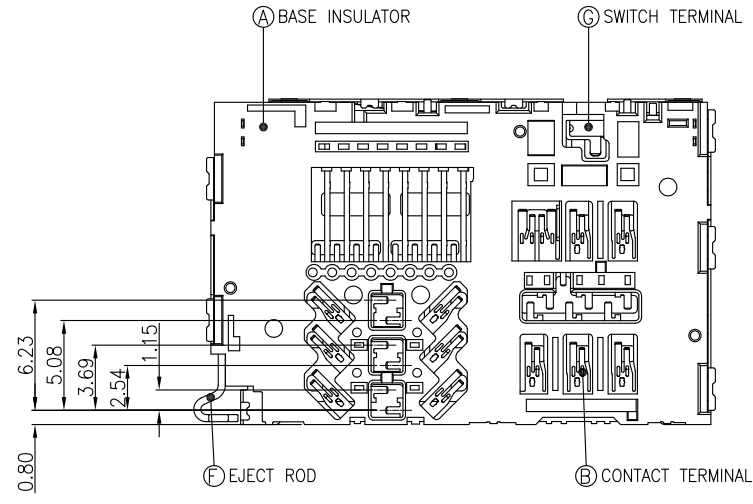
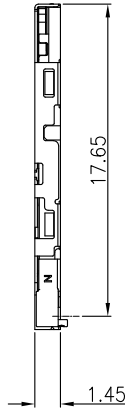
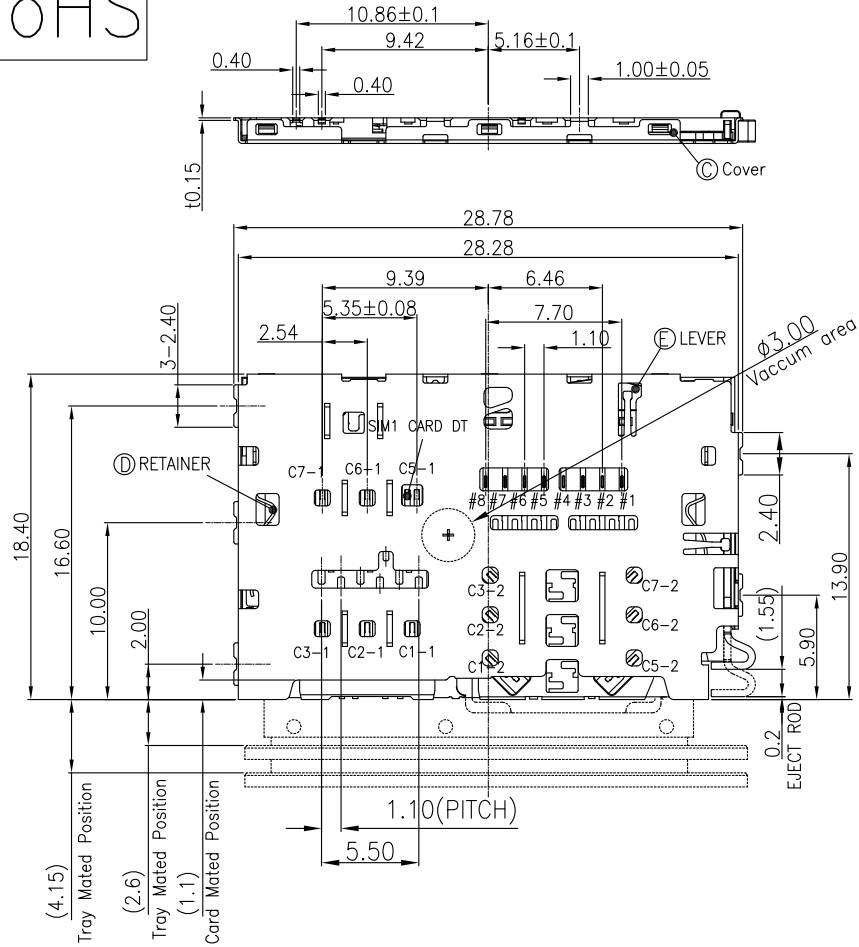
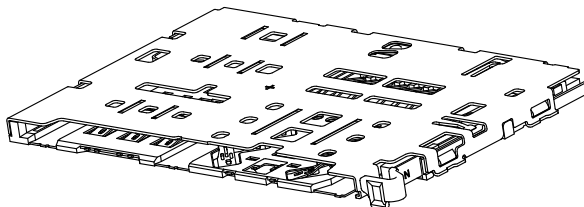


RoHS

REV.	LOCAS.	DESCRIPTION	DRAW.	DATE.
A	MODIFY	NEW	Sam	06/23'16



Tray Mated Position (4.15)  
 Tray Mated Position (2.6)  
 Card Mated Position (1.1)



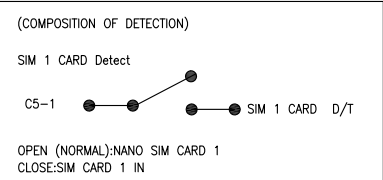
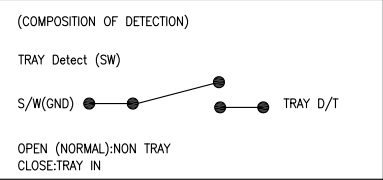
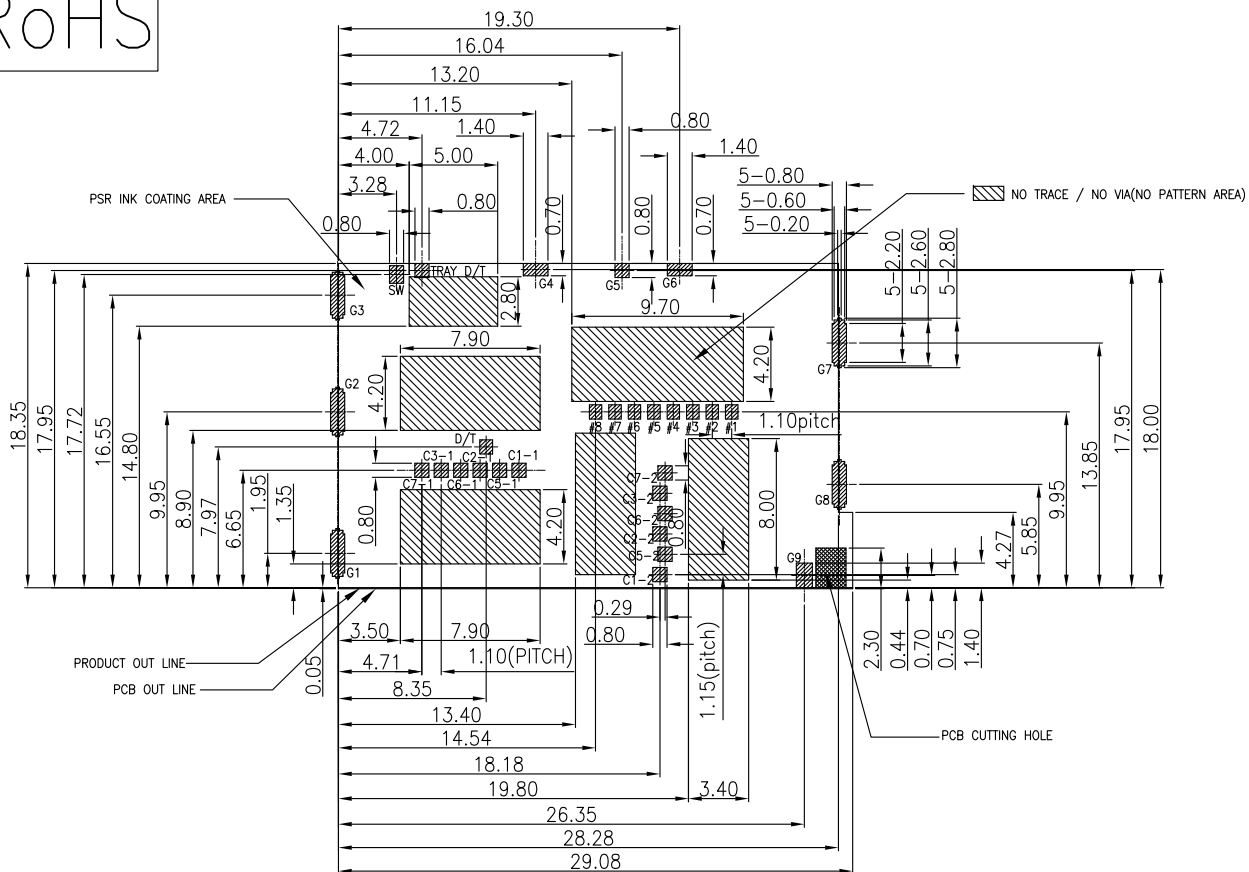
G	SWITCH TERMINAL	Copper Alloy T=0.15MM	Contact:Au flash Over Ni Lead:Au flash Over Ni
F	EJECT ROD	Stainless Steel T=0.40MM	-
E	LEVER	Stainless Steel T=0.45MM	-
D	RETAINER	Stainless Steel T=0.15MM	Nickel
C	COVER	Stainless Steel T=0.15MM	Fixed:Au flash Over Ni BASE:Nickel
B	CONTACT TERMINAL	Copper Alloy T=0.10MM	Contact:Au flash Over Pd+Ni Lead:Au flash Over Ni
A	HOUSING	LCP	LCP BLACK
NO.	Description	Material	Finish

MEASURE POINT: (QP)  
 QUADRANT POINT (QP)  
 TANGENCY POINT (TP)  
 INTERSECTION POINT (IP)



UNLESS OTHERWISE SPECIFIED, TOLERANCE:	DESING	DATE	TITLE:
X. ±0.25	CHECKED	DATE	3 IN 2 NANO SIM+MICRO SD CARD
X.x ±0.20	APPROVED	DATE	SOCKET H=1.45MM TRAY
X.xx ±0.15	PART NO: 1061160134	REV: A	SCALE: 1:1
ANGULAR ±3°	DRAWING NO: C-1061160134	SIZE: A4	UNIT: mm
		SHEET: 1/4	

RoHS



G1-G9	GND OR NOT CONNECT
SW	TRAY DETECTOR
TRAY D/T	GROUND
D/T	SIM DETECTOR

Nano SIM Circuit Description:

Micro SD Circuit Description:

PIN No.	FUNCTION
C1	VCC
C2	RST
C3	CLK
C4	RESERVED
C5	GND
C6	VPP
C7	I/O
C8	RESERVED

PIN No.	FUNCTION
S1	DAT2
S2	CT/DAT3
S3	CMD
S4	VDD
S5	CLK
S6	VSS
S7	DAT0
S8	DAT1

MEASURE POINT: (QP)  
 QUADRANT POINT (QP)  
 TANGENCY POINT (TP)  
 INTERSECTION POINT (IP)

UNLESS OTHERWISE SPECIFIED, TOLERANCE:  
 X. ±0.25  
 X.x ±0.20  
 X.xx ±0.15  
 ANGULAR ±3°



DESIGN	DATE	TITLE:	3 IN 2 NANO SIM+MICRO SD CARD SOCKET H=1.45MM TRAY		
CHECKED	DATE				
APPROVED	DATE				
PART NO:	1061160134	REV: M	SCALE: 1:1	UNIT: mm	
DRAWING NO:	C-1061160134	SIZE: A4	SHEET: 2/4		